

Disclosure No. 01-0509

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

BOON SUAN JEUNG, ET AL.

Mai Huong C. Tran EXAMINER:

2818 ART UNIT:

CONF. NO: 7237

APPLICATION NO.:

10/033,340

FILED:

DECEMBER 26, 2001

FOR: MULTI-SUBSTRATE MICROELECTRONIC PACKAGES AND METHODS FOR

MANUFACTURE

Amendment in Response to Restriction Requirement

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated April 3, 2003, please amend the application as follows.